

TrenchT2[™] GigaMOS[™] Power MOSFET

IXTK550N055T2 IXTX550N055T2

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

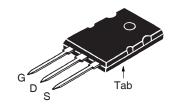


Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}C$ to 175°C	55	V	
V _{DGR}	$T_J = 25^{\circ}C$ to 175°C, $R_{gs} = 1M\Omega$	55	V	
$V_{\rm GSS}$	Continuous	± 20	V	
V _{GSM}	Transient	± 30	V	
I _{D25}	T _C = 25°C (Chip Capability)	550	Α	
I _{L(RMS)}	External Lead Current Limit	160	Α	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	1375	Α	
I,	T _C = 25°C	200	Α	
I _A E _{AS}	$T_{c}^{\circ} = 25^{\circ}C$	3	J	
P_{D}	T _C = 25°C	1250	W	
T _J		-55 +175	°C	
T _{JM}		175	°C	
T _{stg}		-55 +175	°C	
T _L	1.6mm (0.062 in.) from Case for 10s	300	°C	
T _{SOLD}	Plastic Body for 10s	260	°C	
M _d	Mounting Torque (TO-264)	1.13/10	Nm/lb.in.	
F _c	Mounting Force (PLUS247)	20120 /4.527	N/lb.	
Weight	TO-264	10	g	
	PLUS247	6	g	

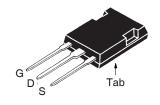
SymbolTest ConditionsChara $(T_J = 25^{\circ}C \text{ Unless Otherwise Specified})$ Min.			acteristic Values Typ. Max.		
BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	55			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250\mu A$	2.0		4.0	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} =$	150°C		10 1	μA mA
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 100A, Notes 1 & 2$	2		1.6	mΩ

 $V_{DSS} = 55V$ $I_{D25} = 550A$ $R_{DS(on)} \le 1.6m\Omega$

TO-264 (IXTK)



PLUS247 (IXTX)



G = Gate D = DrainS = Source Tab = Drain

Features

- International Standard Packages
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters and Off-Line UPS
- Primary-Side Switch
- High Speed Power Switching Applications



Symbol	•		cteristic	teristic Values	
$(T_J = 25^{\circ}C,$	Unless Otherwise Specified)	Min.	Тур.	Max.	
g _{fs}	$V_{DS} = 10V, I_{D} = 60A, \text{ Note } 1$	90	150	S	
C _{iss}			40	nF	
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		4970	pF	
C _{rss}			1020	pF	
\mathbf{R}_{GI}	Gate Input Resistance		1.36	Ω	
t _{d(on)}	Resistive Switching Times		45	ns	
t _r	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 200A$		40	ns	
t _{d(off)}	$R_{\rm G} = 1\Omega$ (External)		90	ns	
t _f	G		230	ns	
$Q_{g(on)}$			595	nC	
Q _{gs}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{DSS}$		150	nC	
Q_{gd}			163	nC	
R _{thJC}				0.12 °C/W	
R _{thCS}			0.15	°C/W	

Source-Drain Diode

Symbol Test Conditions Characteristic V			Value	s
$(T_J = 25^{\circ}C, Unless Otherwise Specified)$	Min.	Тур.	Max.	
$V_{gS} = 0V$			550	Α
\mathbf{I}_{SM} Repetitive, Pulse Width Limited by \mathbf{T}_{JM}			1700	Α
V_{SD} $I_F = 100A, V_{GS} = 0V, Note 1$			1.2	V
$ \begin{cases} \mathbf{I}_{rr} \\ \mathbf{I}_{RM} \\ \mathbf{Q}_{RM} \end{cases} \begin{cases} \mathbf{I}_{F} = 100 \text{A}, \mathbf{V}_{GS} = 0 \text{V} \\ -\text{di/dt} = 100 \text{A}/\mu \text{s} \\ \mathbf{V}_{R} = 27.5 \text{V} \end{cases} $		100 5 250		ns A nC

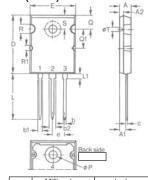
Notes: 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

2. Includes lead resistance.

ADVANCE TECHNICAL INFORMATION

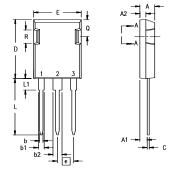
The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-264 (IXTK) Outline



Dim.	Millimeter		Inches	
DIIII.	Min.	Max.	Min.	Max.
Α	4.82	5.13	.190	.202
A1	2.54	2.89	.100	.114
A2	2.00	2.10	.079	.083
b	1.12	1.42	.044	.056
b1	2.39	2.69	.094	.106
b2	2.90	3.09	.114	.122
С	0.53	0.83	.021	.033
D	25.91	26.16	1.020	1.030
Е	19.81	19.96	.780	.786
е	5.46 BSC		.215 BSC	
J	0.00	0.25	.000	.010
K	0.00	0.25	.000	.010
L	20.32	20.83	.800	.820
L1	2.29	2.59	.090	.102
Р	3.17	3.66	.125	.144
Q	6.07	6.27	.239	.247
Q1	8.38	8.69	.330	.342
R	3.81	4.32	.150	.170
R1	1.78	2.29	.070	.090
S	6.04	6.30	.238	.248
Т	1.57	1.83	.062	.072

PLUS 247™ (IXTX) Outline



Terminals: 1 - Gate

- 2 Drain (Collector)
- 3 Source (Emitter) 4 Drain (Collector)

Dim.	Millimeter		Incl	nes
	Min.	Max.	Min.	Max.
Α	4.83	5.21	.190	.205
A,	2.29	2.54	.090	.100
A ₂	1.91	2.16	.075	.085
b	1.14	1.40	.045	.055
b₁	1.91	2.13	.075	.084
b ₂	2.92	3.12	.115	.123
С	0.61	0.80	.024	.031
D	20.80	21.34	.819	.840
E	15.75	16.13	.620	.635
е	5.45 BSC		.215 BSC	
L	19.81	20.32	.780	.800
L1	3.81	4.32	.150	.170
Q	5.59	6.20	.220	0.244

4.83

.170

.190

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Fig. 1. Output Characteristics @ T_J = 25°C

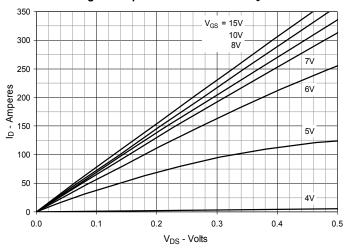


Fig. 2. Extended Output Characteristics @ T_J = 25°C

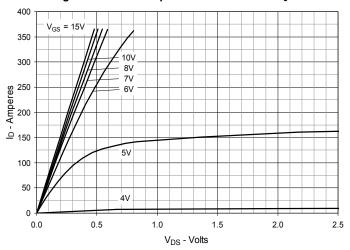


Fig. 3. Output Characteristics @ T_J = 150°C

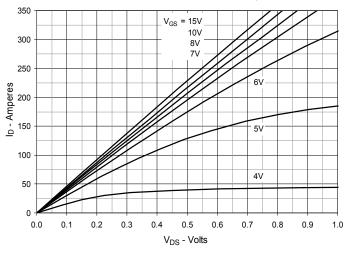


Fig. 4. Normalized R_{DS(on)} vs. Junction Temperature

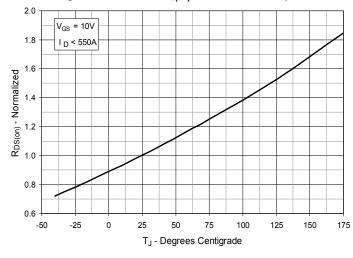


Fig. 5. Normalized R_{DS(on)} vs. Drain Current

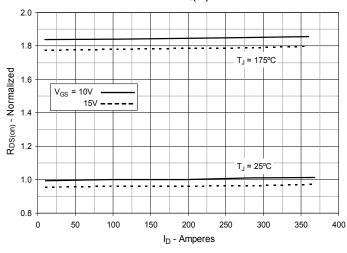
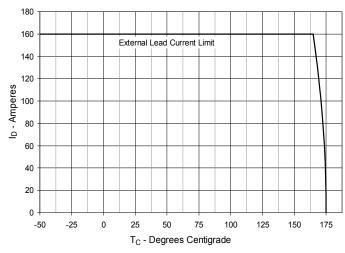
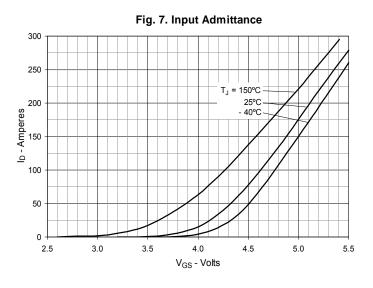
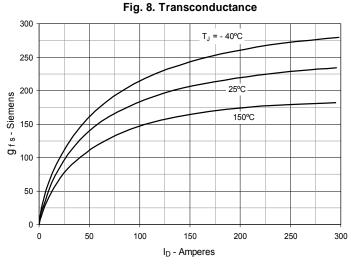


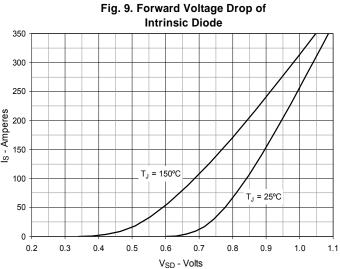
Fig. 6. Drain Current vs. Case Temperature

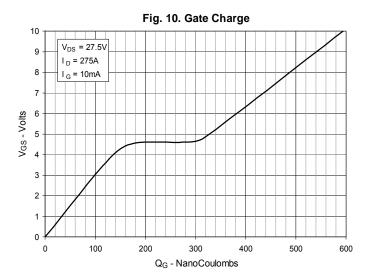


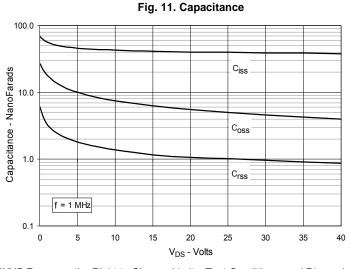


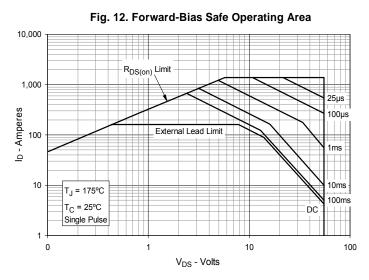












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32

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Vs. Junction Temperature

48

46

R_G = 10, V_{GS} = 10V

V_{DS} = 27.5V

44

42

40

40

1 D = 200A

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36

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Fig. 13. Resistive Turn-on Rise Time

Fig. 14. Resistive Turn-on Rise Time vs. Drain Current $R_G = 1\Omega$, $V_{GS} = 10V$ 46 V_{DS} = 27.5V 44 tr-Nanoseconds T_J = 125°C 42 40 38 $T_J = 25^{\circ}C$ 36 34 32 40 60 80 100 120 140 200 I_D - Amperes

Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

75

T_J - Degrees Centigrade

85

95

105

115

125

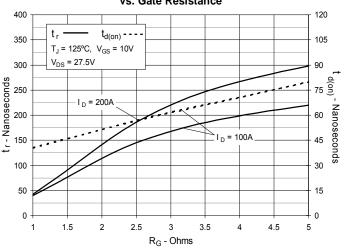


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

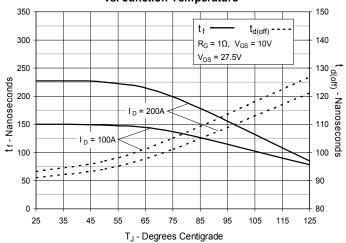


Fig. 17. Resistive Turn-off Switching Times

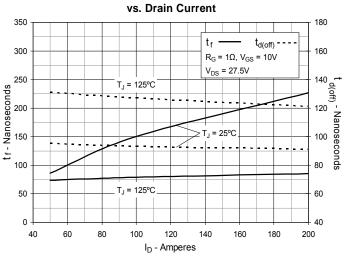
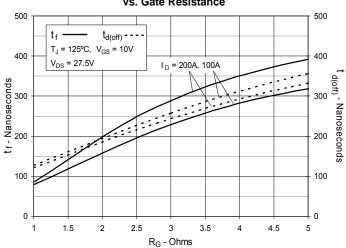
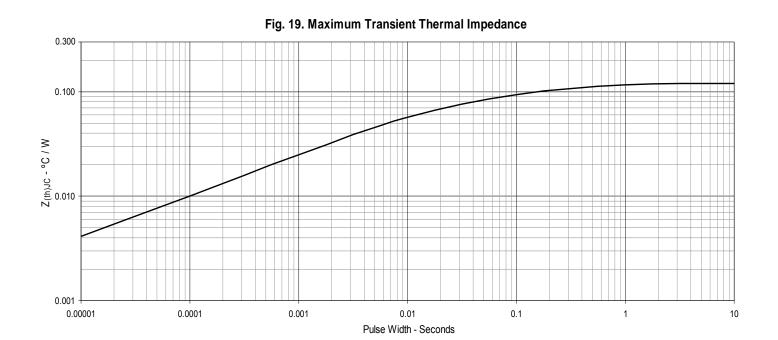


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance







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